

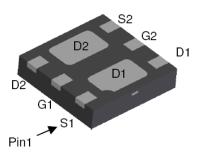
P-Channel Enhancement Mode Field Effect Transistor

Features

High density Cell Design for Low $R_{\text{DS(ON)}}$ Voltage controlled small signal switch Reliable and Rugged

Pin Configurations

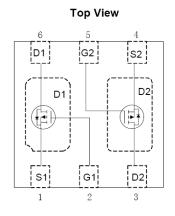
U-DFN2020-6



Bottom View

• General Description

These P-Channel enhancement mode field effect transistors are produced using high cell density, DMOS technology.



DFN2020-6

Absolute Maximum Ratings

 $@T_A=25$ °C unless otherwise noted

Parameter	Symbol	Ratings	Unit
Drain - Source Voltage	V _{DSS}	-20	V
Gate –Source Voltage	V _{GS}	±8	V
Drain Current (Continuous)	I _D	-2.8	А
Drain Current (Pulse)	I _{DP}	-10	А
Power Dissipation	P _D	1.25	W
Operating Temperature	Τ _J	-55~150	$^{\circ}$ C
Storage Temperature	T _{STG}	-55~150	$^{\circ}$ C

Electrical Characteristics @T_A=25°C unless otherwise noted

Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = -250uA$	-20			V		
Drain Cut-off Current	I _{DSS}	V _{DS} = -20 V , V _{GS} = 0V			-1	uA		
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = \pm 8 \text{ V}$, $V_{DS} = 0 \text{ V}$			±110	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(th)}	I_D = -250 uA , V_{DS} = V_{GS}	-0.45		-1.5	V		
Drain-Source On-state Resistance	R _{DS(on)}	$I_D = -2.8 \text{ A}$, $V_{GS} = -4.5 \text{V}$			73	mΩ		
		I _D = -2A , V _{GS} = -2.5V			116	mΩ		
Forward Transconductance	g FS	$V_{DS} = -5V$, $I_D = -2.8A$		6.5		S		
On-State Drain Current ¹	ID _(on)	$V_{DS} = -5V, V_{GS} = -4.5V$	-6			۸		
		$V_{DS} = -5V, V_{GS} = -2.5V$	-3			Α		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C _{iss}	\\		415		pF		
Output Capacitance	Coss	$V_{DS} = -6V$, $V_{GS} = 0V$ f = 1 MHz		223		pF		
Feedback Capacitance	C _{rss}	I = I IVITZ		87		pF		
SWITCHING CHARACTERISTICS								
Turn-on Delay Time	t _{d (on)}	V_{DD} = -6V , R_L = 6 Ω , I_D = -1.0A,		13	25	ns		
Turn-off Delay Time	t _{d(off)}	V_{GEN} = -4.5V, R_G = 6 Ω		42	70	ns		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Drain-Source Diode Forward Current	Is				-0.75	Α		
Drain-Source Diode Forward Voltage	V _{SD}	Is = -1.6A, V _{GS} = 0V	-0.5		-1.2	V		

Notes:

- 1. Pulse width limited by maximum junction temperature. Pulse test: PW≤300 µ s, duty cycle≤2%.
- 2. For design AID only, not subject to production testing. Switching time is essentially independent of operating temperature.

Typical Performance Characteristics

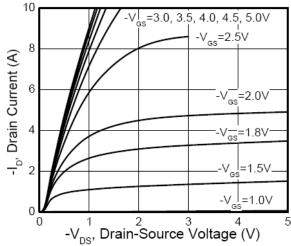
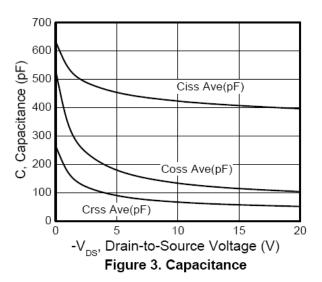


Figure 1. Output Characteristics



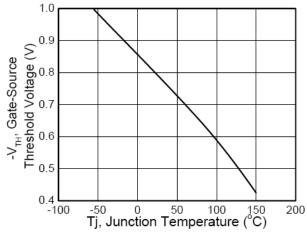


Figure 5. Gate Thershold Vs. Temperature

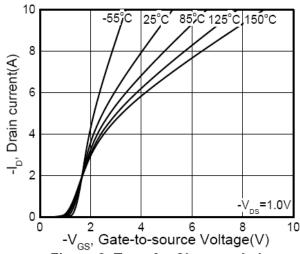


Figure 2. Transfer Characteristics

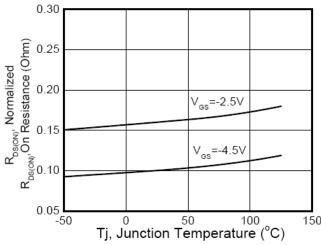
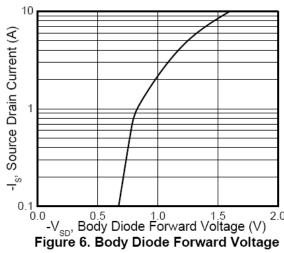
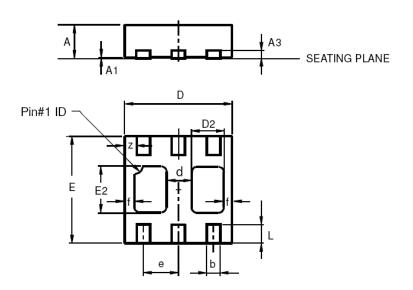


Figure 4. On Resistance Vs. Temperature

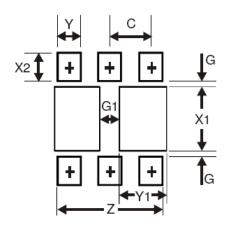


Vs. Source Current

Package Information DFN2020-6



U-DFN2020-6 Type B					
Dim	Min	Max	Тур		
Α	0.545	0.605	0.575		
A1	0	0.05	0.02		
A3	_	_	0.13		
b	0.20	0.30	0.25		
D	1.95	2.075	2.00		
d	_	_	0.45		
D2	0.50	0.70	0.60		
е	_	_	0.65		
Е	1.95	2.075	2.00		
E2	0.90	1.10	1.00		
f		_	0.15		
┙	0.25	0.35	0.30		
Z			0.225		
All Dimensions in mm					



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Υ	0.37
Y1	0.70
С	0.65

IMPORTANT NOTICE

The information in this document has been carefully reviewed and is believed to be accurate. Nonetheless, this document is subject to change without notice. FORSEMI assumes no responsibility for any inaccuracies that may be contained in this document, and makes no commitment to update or to keep current the contained information, or to notify a person or organization of any update. FORSEMI reserves the right to make changes, at any time, in order to improve reliability, function or design and to attempt to supply the best product possible.